**ISSP2017**

**Exhibit APPLICATION form**

|  |  |  |
| --- | --- | --- |
| Company Name |  | |
| Address |  | |
| Name of corresponding person  Last name  Middle name  First name | | Phone  Fax  E-mail |
| Application Date | | Exhibit Fee per Unit  \120,000 |
|
| Number of Units for Exhibition  (1unit=1panel and 1 table)  \_\_\_\_\_\_\_\_ Units |
| AC100V-2A Power Supply (please check)  🞎 use 🞎 don’t use  Free advertisement page on the proceedings and on the programs  🞎 yes 🞎 no  Link to your homepage from ISSP2017 website  🞎 yes 🞎 no  Your URL\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_  **(Please attach your banner image file)**  CM presentation by Powerpoint automatic slide  🞎 yes 🞎 no | |
|
| Total Fee  \ \_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_\_ |
| Remarks | | |

**Application dead line is May 15, 2017**

**Application form (only this page) is to be sent to the following address via Email.**

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